

# Application Note

## DA9313 Frequently Asked Questions

AN-PM-090

### Abstract

*Using a question-and-answer format, this application note presents solutions to various application topics when designing-in the DA9313 into a system.*

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**DA9313 Frequently Asked Questions****Contents**

<b>Abstract</b> .....	<b>1</b>
<b>Contents</b> .....	<b>2</b>
<b>1 Terms and Definitions</b> .....	<b>3</b>
<b>2 References</b> .....	<b>3</b>
<b>3 Introduction</b> .....	<b>4</b>
<b>4 Frequently Asked Questions</b> .....	<b>4</b>
4.1 External Components.....	4
4.2 Power Voltage Converter .....	4
4.3 I <sup>2</sup> C Compatible Interface .....	5
4.4 Other .....	6
<b>Revision History</b> .....	<b>8</b>

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## DA9313 Frequently Asked Questions

### 1 Terms and Definitions

OVP	Over Voltage Protection
PVC	Power Voltage Converter
SoC	System on Chip
OD	Open Drain

### 2 References

- [1] DA9313 Datasheet, Rev 3.0, Dialog Semiconductor
- [2] ER-PM-003, DA9313 Startup Considerations, Rev 1.0, Dialog Semiconductor

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## DA9313 Frequently Asked Questions

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### 3 Introduction

The purpose of this applications note is to help customers understand the various aspects of the DA9313 converter when designed into their systems.

## 4 Frequently Asked Questions

### 4.1 External Components

#### 1. Could the flying capacitor value or quantity be reduced?

Reducing the flying capacitor value will impact efficiency. Reducing the quantity of capacitors may impact reliability. The flying capacitor must have the appropriate ripple current rating to meet the maximum 20 °C temperature rise requirement.

#### 2. What is the flying capacitors ( $C_{FLY}$ ) effective capacitance?

$C_{FLY}$  per phase must be rated to  $\geq 18 \mu\text{F}$  @ 5 V,  $I_{RMS} = 8 \text{ A}$ . For a lower output load current, contact [ic-support@diasemi.com](mailto:ic-support@diasemi.com) for technical support.

Note that there are two  $C_{FLY}$  in parallel per phase, therefore each capacitor must be rated to  $\geq 9 \mu\text{F}$  @ 5 V,  $I_{RMS} = 4 \text{ A}$ .

#### 3. What is the V<sub>CORE</sub> capacitor (CO\_V<sub>CORE</sub>) effective capacitance?

The external CO\_V<sub>CORE</sub> effective capacitance should be min 0.5  $\mu\text{F}$ , max 1.3  $\mu\text{F}$  and is typically 1.0  $\mu\text{F}$ .

What are VIN to VOUT and VOUT to GND decoupling capacitors used for? Could I reduce their values?

They are used to decouple the internal FET drivers that are connected to VIN, VOUT and GND.

The VIN to VOUT capacitor value could be reduced to 1  $\mu\text{F}$  because there should be a localized decoupling to VIN (2 \* 4.7  $\mu\text{F}$  or 1 \* 10  $\mu\text{F}$  as recommended in the datasheet). The VOUT to GND cap must be 4.7  $\mu\text{F}$  as specified in the datasheet.

#### 4. Could I add a large decoupling capacitor on VIN, as recommended in the datasheet, knowing that I need to meet the USB requirements limiting the capacitor to 1 $\mu\text{F}$ ?

Yes. Usually an OVP IC is added at the front end of the DA9313, this limitation is for the OVP IC.

#### 5. Has the DA9313 got an integrated over-voltage protection (OVP)?

No. The following tiny external OVP devices could be used: [TI TPD1S514](#), [Fairchild FPF2280](#), and [Kinetic KTS1682](#). They all are pinout compatible parts with a very similar feature set.

#### 6. What is the maximum output capacitance allowed at the output of the PVC?

470  $\mu\text{F}$  (it can be distributed).

### 4.2 Power Voltage Converter

#### 7. What is the allowed maximum DC load current of the PVC?

Typically, it is 8.2A (DC) continuously (10A peak) but it depends on the use case.

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## DA9313 Frequently Asked Questions

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### 8. What defines the PVC startup time?

The value of the total of the output plus flying capacitors and the startup current set by I\_STUP\_PVC, configured from 500 mA to 2 A. This assumes no load is drawn during the startup phase.

### 9. When should I apply a load at the output of the PVC?

Monitor that the PVC output reaches  $V_{DD}/2 - 80$  mV before a load greater than half of the I\_STUP\_PVC value is applied to its output for both standalone and master/slave modes.

In applications where a load is applied during the startup phase, refer to Technical Note ER-PM-003 [2].

### 10. Could I operate the PVC above 10.5 V?

No. When the PVC is enabled (PVC\_EN = 1),  $V_{IN}$  must be limited to 10.5 V maximum.

When the PVC is switching, the power MOSFETs are subjected to hot carrier injections and to guarantee the life-time of the product, the maximum drain-to-source voltage is restricted to 10.5 V.

If the PVC is disabled (PVC\_EN = 0), 20 V could be applied to  $V_{IN}$  assuming that  $V_{IN}$  ramp  $< 1$  V/ $\mu$ s.

When the PVC is not switching, there is no hot carrier stress. In this case, the maximum drain to source voltage (20 V) is limited by the snap-back characteristics of the power MOSFETs.

### 11. What is the limitation on the slew rate of the input voltage?

Any voltage applied to  $V_{IN}$  has to have a rise time less than  $< 1$  V/ $\mu$ s to avoid noise capacitively coupling through the IC.

### 12. Could I operate the PVC below 5 V?

No. The internal FET drivers operating voltage is 5 V minimum.

## 4.3 I<sup>2</sup>C Compatible Interface

### 13. Could the DA9313 slave be controlled by I2C?

No. The slave I<sup>2</sup>C lines must be grounded.

### 14. What is the master/slave interface (MS\_IF) protocol on GPIO\_0?

GPIO\_0, used as MS\_IF, voltage domain is VCORE.

- GPIO\_0 is asserted high during the PVC ramp up.
- Then it remains low until a load higher than approximately 3 A is applied
- The GPIO\_0 then starts toggling to control the switching of the slave's phases; phase 1 and phase 2 in turn. The more load that is applied the more the slave switches between phase 1 and phase 2.
- When the PVC is disabled the master sends a 100 ns shutdown pulse (low) to the slave.
- The slave stops switching, GPIO\_0 will then stay high during the duration of the PVC shutdown phase and eventually GPIO\_0 will be asserted low.

### 15. What is the voltage domain of all IOs (GPIOs and I2C) when operating the DA9313 in master/slave?

## DA9313 Frequently Asked Questions

All IOs are reference to V<sub>CORE</sub> (4 V). They may need to be level shifted externally. VDDIO\_EN and VDDIO\_CONF controls are ignored.

### 16. What is the master/slave current sharing ratio?

From approximately 3 A both the master and slave start sharing the output load. When the output load reaches approximately 4 A the current sharing is approximately equally distributed.

### 17. How does the master know when to operate the slave?

By monitoring V<sub>OUT</sub> and comparing it to the voltage at the master slave interface level (V<sub>MSI</sub>). This monitoring is used to trigger the slave device via the master/slave interface (MS\_IF). The level at which the master triggers the slave is defined in PVC\_MS\_DROP.

- When the V<sub>OUT</sub> voltage decreases beyond V<sub>MSI</sub> due to progressive output loading, the master DA9313 enables the slave DA9313 over MS\_IF.
- When the V<sub>OUT</sub> voltage increases above V<sub>MSI</sub> + V<sub>PVC\_MS\_HYST</sub> (defined in register bits PVC\_MS\_HYST), the master DA9313 disables the slave DA9313 over MS\_IF.

$$V_{MSI} = V_{CCM} - V_{PVC\_MS\_DROP}$$

Where:

- $V_{CCM} = (V_{BAT}/2 - V_{PVC\_DROP} - V_{PVC\_HYSTMAX})$
- V<sub>PVC\_HYSTMAX</sub> is a constant value of 30 mV

### 18. Could I use the master GPIO\_1 when operating in master/slave?

Yes. GPIO\_1 is used as SLAVE\_ID. For the slave, GPIO\_1 is connected to its own V<sub>CORE</sub>. For the master, GPIO\_1 must be un-driven by the System on Chip (SoC).

If the master's GPIO\_1 is used in open drain (OD) with an external pull-up then Dialog would recommend that the pull-up resistor must be > 820 kΩ to prevent a false SLAVE\_ID recognition.

Could I communicate with the DA9313 in POWER\_DOWN mode?

No. The host processor should wait for DA9313 to reach the ACTIVE mode following a startup from OFF or POWER\_DOWN before starting the I<sup>2</sup>C communication with DA9313.

### 19. If I don't use the master or standalone I2C lines, how should I connect them?

If the I<sup>2</sup>C is not being used, then the I<sup>2</sup>C lines must be connected to GND.

## 4.4 Other

### 20. Could I overdrive the nONKEY pin?

No. The nONKEY port should be never externally overdriven to a voltage higher than V<sub>CORE</sub> (4 V).

### 21. Is there a Linux driver available for DA9313?

A Linux driver will be available in March 2017. Please contact [ic-support@diasemi.com](mailto:ic-support@diasemi.com) for technical support.

### 22. What are the VIH and VIL levels of the integrated GPI Schmitt trigger?

**DA9313 Frequently Asked Questions**

$V_{IH}$  is 60 % to 67.9 % of IOVDD and  $V_{IL}$  is 34.7 % to 40.2 % of IOVDD over PVT (Process Voltage Temperature).

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**DA9313 Frequently Asked Questions****Revision History**

Revision	Date	Description
2.1	23-Feb-2022	Document rebranded to Renesas.
2.0	30-Oct-2018	Additional descriptions.
<b>Change details:</b> <ul style="list-style-type: none"><li>● <a href="#">Section 4.2: Power Voltage Converter</a><ul style="list-style-type: none"><li>○ Additional information to questions 8, 9, and 10</li><li>○ New question (11) and answer</li></ul></li></ul>		
1.0	21-Feb-2017	Initial version.



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DA9313 Frequently Asked Questions

Status Definitions

Status	Definition
DRAFT	The content of this document is under review and subject to formal approval, which may result in modifications or additions.
APPROVED or unmarked	The content of this document has been approved for publication.

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu

Koto-ku, Tokyo 135-0061, Japan

[www.renesas.com](http://www.renesas.com)

### Contact Information

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